504014739 09/21/2016

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4061396

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
KOICHI YOSHIDA		08/22/2016
ΚΑΖUΤΑΚΑ ΜΙΥΑΜΟΤΟ		08/22/2016
KATSUMASA KAWABATA		08/22/2016
HENRY SANFORD-CRANE		08/22/2016
HUI BIN HUANG		08/23/2016
GEORGE C. JACOB		08/24/2016
SHUIYUAN LUO		09/05/2016

RECEIVING PARTY DATA

Name:	Rohm and Haas Electronic Materials CMP Holdings, Inc.
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Postal Code:	19713

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15229009

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ATTORNEY DOCKET NUMBER:	79430
NAME OF SUBMITTER:	PATRICIA A. CONNELL
SIGNATURE:	/Patricia A. Connell/
DATE SIGNED:	09/21/2016

Total Attachments: 2

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Application Serial Number: 15/229,009 Filing Date: August 4, 2016 Attorney Docket No.: 79430

ASSIGNMENT OF PATENT APPLICATION

We/I, the undersigned

Koichi Yoshida of Kyoto, Japan; Kazutaka Miyamoto of Mie, Japan; Katsumasa Kawabata of Kyoto, Japan; Henry Sanford-Crane of Elkton, Maryland; Hui Bin Huang of Monroeville, New Jersey; George C. Jacob of Newark, Delaware and Shuiyuan Luo of Newark, Delaware

Hereby declare that

We/I are true and first inventor(s) of an invention relating to

TAPERING METHOD FOR POROMERIC POLISHING PAD

22nd

& 5th which is disclosed in an application for Letters Patent in the United States of America, executed the day of August & September ____, 2016 (Case No. 79430); and, for valuable consideration, the receipt and adequacy of which is hereby acknowledged and in fulfillment of our pre-existing obligation of assignment, we hereby sell, assign and transfer unto Rohm and Haas Electronic Materials CMP Holdings, Inc., a corporation organized and existing under the laws of the State of Delaware in the United States of America and having its mailing address at 451 Bellevue Road, Newark, Delaware, hereinafter referred to as the assignee, the entire right, title, and interest in and to the aforesaid application for Letters Patent, including any priority rights derived from the aforesaid application for Letters Patent by virtue of the International Convention for the Protection of Industrial Property for any and all member countries of the aforesaid International Convention, and the entire right, title and interest in and to any and all our inventions, whether joint or sole, disclosed in the aforesaid application for Letters Patent, and in and to any and all applications for letters Patent for any such inventions in any country whatsoever, and in and to any and all patents for any such inventions in any country whatsoever, with the sole right to file such applications in its name or ours, including the sole right to file such applications under the aforesaid International Convention, together with the sole right to have said patents granted in its name or ours and to enforce said patents and to sue for and recover profits and damages for any and all infringements thereof, and hereby agree, whenever requested, to communicate to us respecting said inventions, to testify in any legal proceeding, to execute all applications, papers, or instruments necessary or required by said assignee, its successors, assigns, and legal representatives to carry into effect any of the provisions of this instrument, and generally to do everything possible to aid said assignee, its successors, assigns and legal representatives to obtain and enforce proper patent protection for said inventions in any and all countries.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

08/22/2016

Page 1 of 2

Kazutaka Miyamoto

京昌 儿福 Katsumasa Kawabata

Henry Sanford-Crane

 $\frac{\partial F/22/20/6}{DATE}$ $\frac{\partial F/22/20/6}{DATE}$ $\frac{\partial F/22/20/6}{DATE}$

8/23/2016 DATE

Hui Bin Huang

George C. Jacob

Shuiyuan Luo

8/24/2016 DATE

DATE 12016

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RECORDED: 09/21/2016